

## 74VCX32

### Low Voltage Quad 2-Input OR Gate with 3.6V Tolerant Inputs and Outputs

#### General Description

The VCX32 contains four 2-input OR gates. This product is designed for low voltage (1.2V to 3.6V)  $V_{CC}$  applications with I/O compatibility up to 3.6V.

The VCX32 is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

#### Features

- 1.2V to 3.6V  $V_{CC}$  supply operation
- 3.6V tolerant inputs and outputs
- $t_{PD}$   
2.8 ns max for 3.0V to 3.6V  $V_{CC}$
- Power-off high impedance inputs and outputs
- Static Drive ( $I_{OH}/I_{OL}$ )  
±24 mA @ 3.0V  $V_{CC}$
- Uses patented Quiet Series™ noise/EMI reduction circuitry
- Latchup performance exceeds JEDEC 78 conditions
- ESD performance:  
Human body model > 2000V  
Machine model > 250V
- Leadless Pb-Free DQFN package

#### Ordering Code:

Order Number	Package Number	Package Description
74VCX32M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX32BQX (Note 1)	MLP014A	Pb-Free 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74VCX32MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

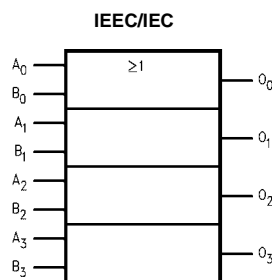
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.  
Pb-Free package per JEDEC J-STD-020B.

**Note 1:** DQFN package available in Tape and Reel only.

Quiet Series™ is a trademark of Fairchild Semiconductor Corporation.

74VCX32 Low Voltage Quad 2-Input OR Gate with 3.6V Tolerant Inputs and Outputs

## Logic Symbol

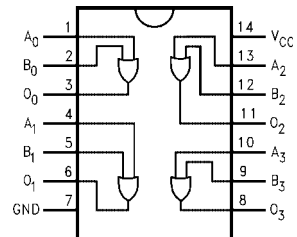


## Pin Descriptions

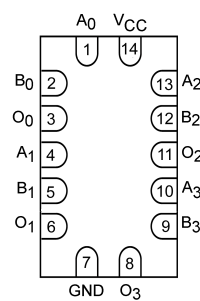
Pin Names	Description
$A_n, B_n$	Inputs
$O_n$	Outputs

## Connection Diagrams

### Pin Assignments for SOIC and TSSOP



### Pad Assignments for DQFN



(Top View)

**Absolute Maximum Ratings** (Note 2)

Supply Voltage ( $V_{CC}$ )	-0.5V to +4.6V
DC Input Voltage ( $V_I$ )	-0.5V to 4.6V
DC Output Voltage ( $V_O$ )	
HIGH or LOW State (Note 3)	-0.5V to $V_{CC} + 0.5V$
$V_{CC} = 0V$	-0.5V to +4.6V
DC Input Diode Current ( $I_{IK}$ )	
$V_I < 0V$	-50 mA
DC Output Diode Current ( $I_{OK}$ )	
$V_O < 0V$	-50 mA
$V_O > V_{CC}$	+50 mA
DC Output Source/Sink Current ( $I_{OH}/I_{OL}$ )	±50 mA
DC $V_{CC}$ or Ground Current per Supply Pin ( $I_{CC}$ or Ground)	±100 mA
Storage Temperature ( $T_{STG}$ )	-65°C to +150°C

**Recommended Operating Conditions** (Note 4)

Power Supply	
Operating	1.2V to 3.6V
Data Retention Only	1.2V to 3.6V
Input Voltage	-0.3V to 3.6V
Output Voltage ( $V_O$ )	
HIGH or LOW State	0V to $V_{CC}$
Output Current in $I_{OH}/I_{OL}$	
$V_{CC} = 3.0V$ to 3.6V	±24 mA
$V_{CC} = 2.3V$ to 2.7V	±18 mA
$V_{CC} = 1.65V$ to 2.3V	±6 mA
$V_{CC} = 1.2V$	±100 $\mu A$
Free Air Operating Temperature ( $T_A$ )	-40°C to +85°C
Minimum Input Edge Rate ( $\Delta t/\Delta V$ )	
$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10 ns/V

**Note 2:** The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

**Note 3:**  $I_O$  Absolute Maximum Rating must be observed.

**Note 4:** Floating or unused inputs must be held HIGH or LOW.

**DC Electrical Characteristics**

Symbol	Parameter	Conditions	$V_{CC}$ (V)	Min	Max	Units
$V_{IH}$	HIGH Level Input Voltage		2.7 - 3.6 2.3 - 2.7 1.65 - 2.3 1.4 - 1.6 1.2	2.0 1.6 $0.65 \times V_{CC}$ $0.65 \times V_{CC}$ $0.65 \times V_{CC}$		V
$V_{IL}$	LOW Level Input Voltage		2.7 - 3.6 2.3 - 2.7 1.65 - 2.3 1.4 - 1.6 1.2		0.8 0.7 $0.35 \times V_{CC}$ $0.35 \times V_{CC}$ $0.05 \times V_{CC}$	V
$V_{OH}$	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$ $I_{OH} = -12 \text{ mA}$ $I_{OH} = -18 \text{ mA}$ $I_{OH} = -24 \text{ mA}$	2.7 - 3.6 2.7 3.0 3.0	$V_{CC} - 0.2$ 2.2 2.4 2.2		V
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 \text{ mA}$ $I_{OH} = -12 \text{ mA}$ $I_{OH} = -18 \text{ mA}$	2.3 - 2.7 2.3 2.3 2.3	$V_{CC} - 0.2$ 2.0 1.8 1.7		
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 \text{ mA}$	1.65 - 2.3 1.65	$V_{CC} - 0.2$ 1.25		
		$I_{OH} = -100 \mu A$ $I_{OH} = -2 \text{ mA}$	1.4 - 1.6 1.4	$V_{CC} - 0.2$ 1.05		
		$I_{OH} = -100 \mu A$	1.2	$V_{CC} - 0.2$		

## DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min	Max	Units
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 $\mu$ A	2.7 - 3.6		0.2	V
		I <sub>OL</sub> = 12 mA	2.7		0.4	
		I <sub>OL</sub> = 18 mA	3.0		0.4	
		I <sub>OL</sub> = 24 mA	3.0		0.55	
		I <sub>OL</sub> = 100 $\mu$ A	2.3 - 2.7		0.2	
		I <sub>OL</sub> = 12 mA	2.3		0.4	
		I <sub>OL</sub> = 18 mA	2.3		0.6	
		I <sub>OL</sub> = 100 $\mu$ A	1.65 - 2.3		0.2	
		I <sub>OL</sub> = 6 mA	1.65		0.3	
		I <sub>OL</sub> = 100 $\mu$ A	1.4 - 1.6		0.2	
		I <sub>OL</sub> = 2 mA	1.4		0.35	
		I <sub>OL</sub> = 100 $\mu$ A	1.2		0.05	
I <sub>I</sub>	Input Leakage Current	0 $\leq$ V <sub>I</sub> $\leq$ 3.6V	1.2 - 3.6		$\pm$ 5.0	$\mu$ A
I <sub>OFF</sub>	Power Off Leakage Current	0 $\leq$ (V <sub>I</sub> ) $\leq$ 3.6V	0		10	$\mu$ A
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	1.2 - 3.6		20	$\mu$ A
		V <sub>CC</sub> $\leq$ V <sub>I</sub> $\leq$ 3.6V	1.2 - 3.6		$\pm$ 20	$\mu$ A
$\Delta$ I <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> - 0.6V	2.7 - 3.6		750	$\mu$ A

## AC Electrical Characteristics (Note 5)

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C		Units	Figure Number
				Min	Max		
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation Delay	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500 $\Omega$	3.3 $\pm$ 0.3	0.6	2.8	ns	Figures 1, 2
			2.5 $\pm$ 0.2	0.8	3.7		
			1.8 $\pm$ 0.15	1.0	7.4		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2k $\Omega$	1.5 $\pm$ 0.1	1.0	14.8	ns	Figures 3, 4
			1.2	1.5	37		
t <sub>OSSL</sub> t <sub>OSLH</sub>	Output to Output Skew (Note 6)	C <sub>L</sub> = 30 pF, R <sub>L</sub> = 500 $\Omega$	3.3 $\pm$ 0.3		0.5	ns	
			2.5 $\pm$ 0.2		0.5		
			1.8 $\pm$ 0.15		0.75		
		C <sub>L</sub> = 15 pF, R <sub>L</sub> = 2k $\Omega$	1.5 $\pm$ 0.1		1.5	ns	
			1.2		1.5		

**Note 5:** For C<sub>L</sub> = 50 pF, add approximately 300 ps to the AC maximum specification.

**Note 6:** Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSSL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

## Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C	Unit
				Typical	
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = V <sub>CC</sub> , V <sub>IL</sub> = 0V	1.8 2.5 3.3	0.25 0.6 0.8	V
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = V <sub>CC</sub> , V <sub>IL</sub> = 0V	1.8 2.5 3.3	-0.25 -0.6 -0.8	V
V <sub>OHV</sub>	Quiet Output Dynamic Valley V <sub>OH</sub>	C <sub>L</sub> = 30 pF, V <sub>IH</sub> = V <sub>CC</sub> , V <sub>IL</sub> = 0V	1.8 2.5 3.3	1.5 1.9 2.2	V

## Capacitance

Symbol	Parameter	Conditions	T <sub>A</sub> = +25°C	Units
			Typical	
C <sub>IN</sub>	Input Capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub> , V <sub>CC</sub> = 1.8V, 2.5V or 3.3V	6	pF
C <sub>OUT</sub>	Output Capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub> , V <sub>CC</sub> = 1.8V, 2.5V or 3.3V	7	pF
C <sub>PD</sub>	Power Dissipation Capacitance	V <sub>I</sub> = 0V or V <sub>CC</sub> , f = 10 MHz, V <sub>CC</sub> = 1.8V, 2.5V or 3.3V	20	pF

## AC Loading and Waveforms (V<sub>CC</sub> 3.3V ± 0.3V to 1.8V ± 0.15V)

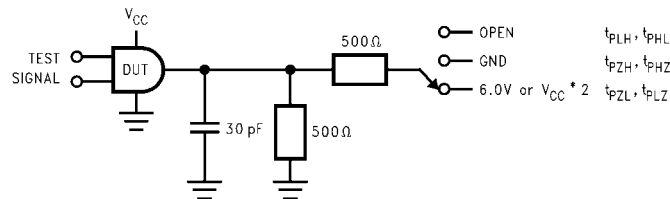


FIGURE 1. AC Test Circuit

TEST	SWITCH
t <sub>PLH</sub> , t <sub>PHL</sub>	Open

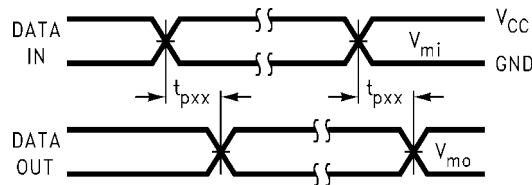
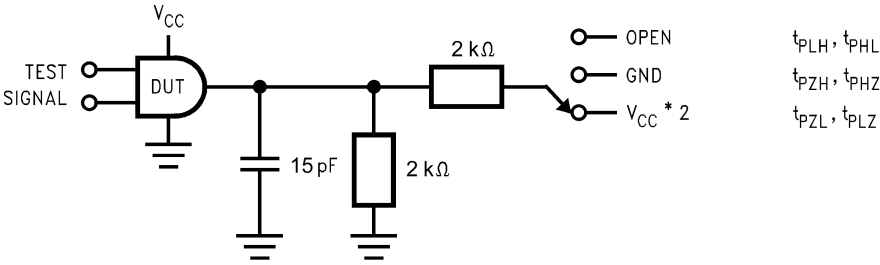


FIGURE 2. Waveform for Inverting and Non-inverting Functions

Symbol	V <sub>CC</sub>		
	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V
V <sub>mi</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>mo</sub>	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2

AC Loading and Waveforms ( $V_{CC} 1.5 \pm 0.1V$  to  $1.2V$ )



TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$	Open
$t_{PZL}$ , $t_{PLZ}$	$V_{CC} \times 2$ at $V_{CC} = 1.5V \pm 0.1V$
$t_{PZH}$ , $t_{PHZ}$	GND

FIGURE 3. AC Test Circuit

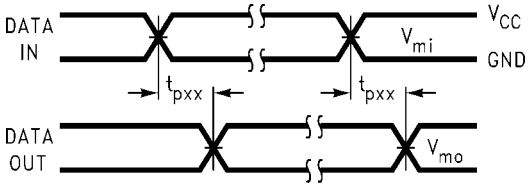


FIGURE 4. Waveform for Inverting and Non-Inverting Functions

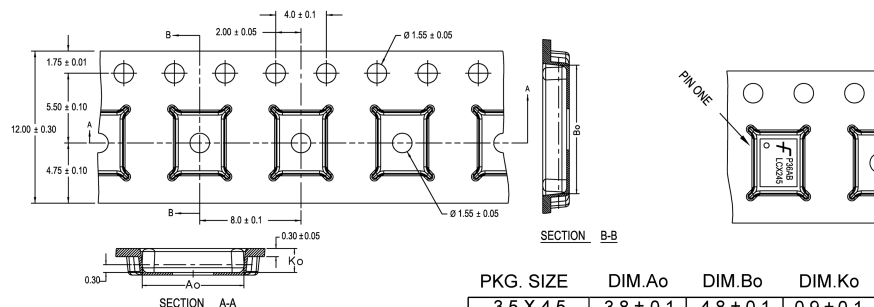
Symbol	$V_{CC}$
	$1.5V \pm 0.1V$
$V_{mi}$	$V_{CC}/2$
$V_{mo}$	$V_{CC}/2$

## Tape and Reel Specification

### Tape Format for DQFN

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	2500/3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

### TAPE DIMENSIONS inches (millimeters)



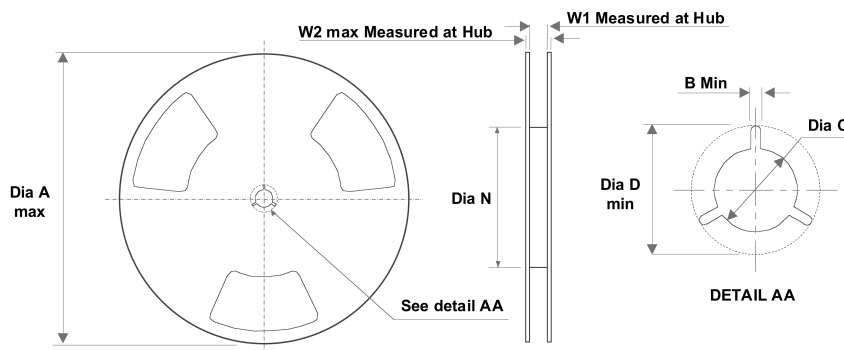
PKG. SIZE	DIM.Ao	DIM.Bo	DIM.Ko
3.5 X 4.5	3.8 ± 0.1	4.8 ± 0.1	0.9 ± 0.1
3.0 X 3.0	3.3 ± 0.1	3.3 ± 0.1	0.9 ± 0.1
2.5 X 4.5	2.8 ± 0.1	4.8 ± 0.1	0.9 ± 0.1
2.5 X 3.5	2.8 ± 0.1	3.8 ± 0.1	0.9 ± 0.1
2.5 X 3.0	2.8 ± 0.1	3.3 ± 0.1	0.9 ± 0.1
2.5 X 2.5	2.8 ± 0.1	2.8 ± 0.1	0.9 ± 0.1

DIMENSIONS ARE IN MILLIMETERS

NOTES: unless otherwise specified

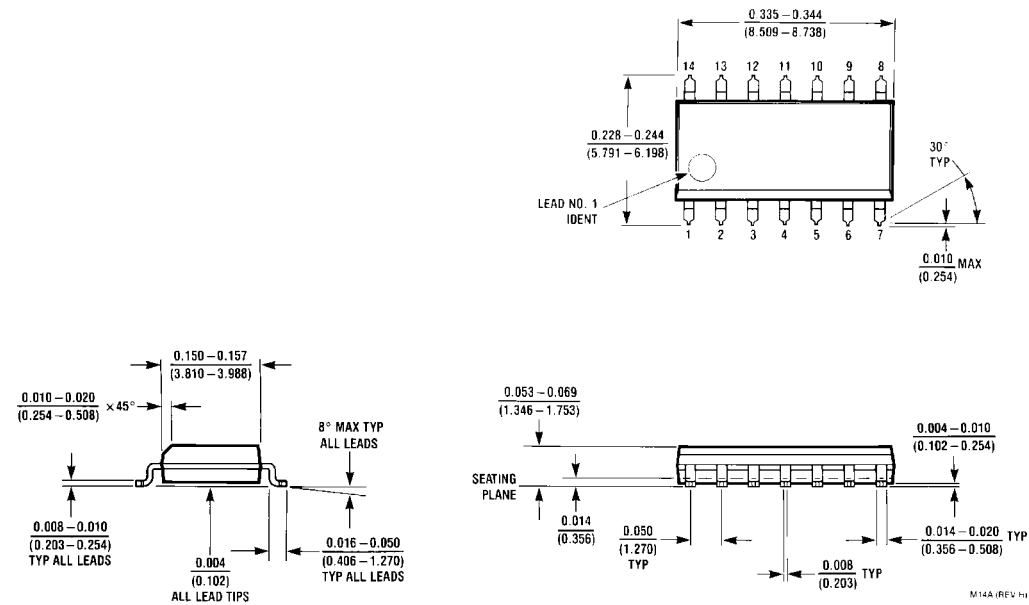
1. Cumulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.
2. Smallest allowable bending radius.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is ±0.002[0.05] for these dimensions on all 12mm tapes.
5. A<sub>o</sub> and B<sub>o</sub> measured on a plane 0.120[0.30] above the bottom of the pocket.
6. K<sub>o</sub> measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Dimension in inches rounded.

### REEL DIMENSIONS inches (millimeters)



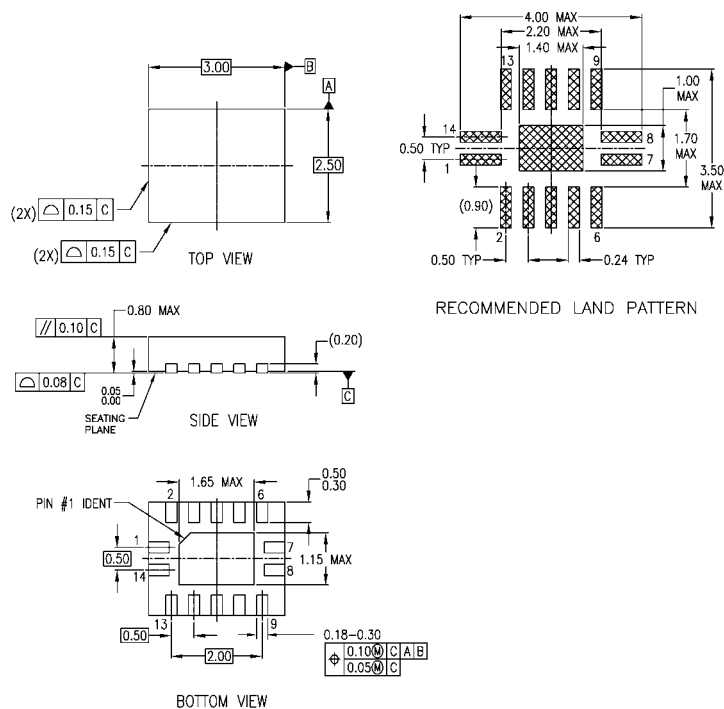
Tape Size	A	B	C	D	N	W1	W2
12 mm	13.0 (330)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	7.008 (178)	0.488 (12.4)	0.724 (18.4)

# Physical Dimensions inches (millimeters) unless otherwise noted



14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow  
Package Number M14A



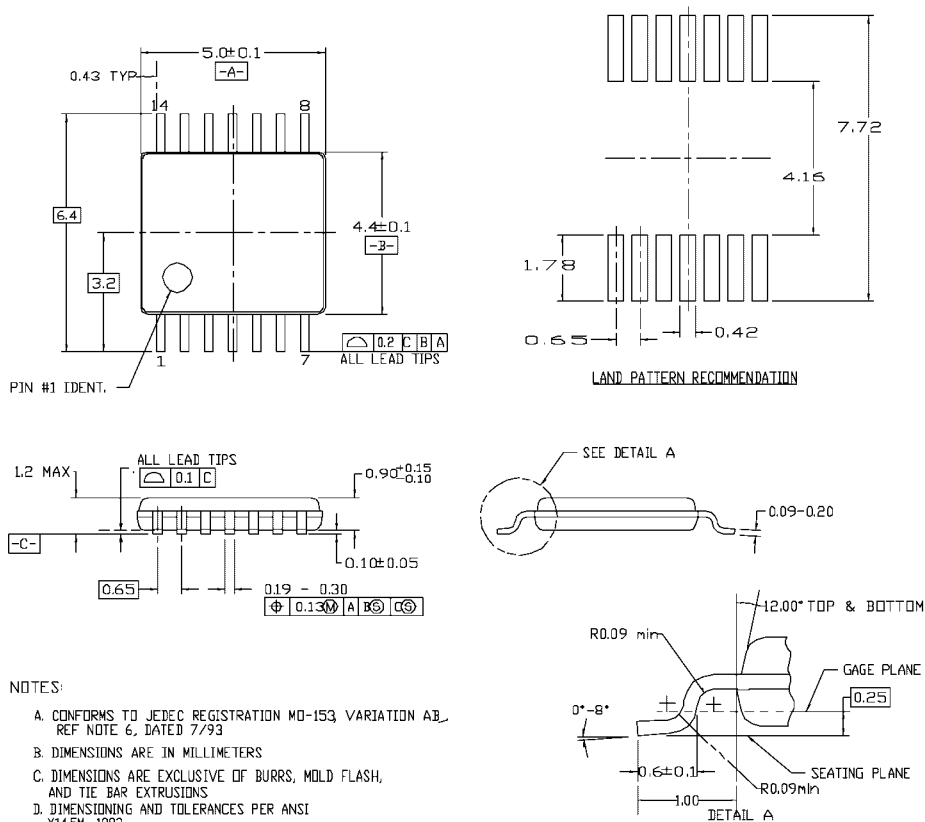
**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

**NOTES:**

- CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP014ArevA

**Pb-Free 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm  
Package Number MLP014A**

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



### NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6, DATED 7/93
- DIMENSIONS ARE IN MILLIMETERS
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982

MTC14revD

14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide  
Package Number MTC14

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- A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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